# AMPLIMITE 050 SERIES II CONNECTOR TYPE B

**Product Specification** 

108-5238-1

1. Scope:

#### 1.1 Contents

This specification covers the requirements for product performance, test methods and quality assurance provisions of counter -EMI products (Fig. 1) of AMPLIMITE 050 Series II connector type В.

The applicable product descriptions and part number are as shown in Fig. 1:

Product No.	Product Name	Remarks
□-174340-□	Plug Connector Kit	Wire Side (AWG #28)
□-175705-□	Plug Connector Kit	Wire Side (AWG #30)
□-174225-□	Horizontal Type Cap Header	M 2.5 Screw
□-174341-□	Horizontal Type Cap Header	w/Retention Leg
□-175714-□	Plug Connector Kit	Wire Side (AWG #28)
□-175644-□	Plug Connector Kit	Wire Side (AWG #28) for Flat Ribbon Cable
□-174339-□	Vertical Type Cap Header	M 2.5 Screw

Fig. 1

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			_	<u> </u>	<u> </u>	R. NISHIMURA	1					
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#### 2. Type of the Products:

Connectors of this product line are designed for wire-to-board mass termination. Further, shield effect is applied for prevention of EMI.

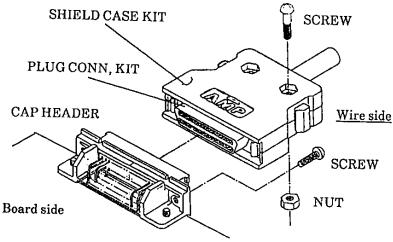


Fig. 2

### 3. Product Specifications:

## Product Design Feature, Construction and Dimensions: 3.1

The product structure, shape and dimensions shall conform to requirements shown on applicable drawings, unless otherwise specified below.

(1) Number of Positions

20, 28, 36, 50, 68 Pos. in 5 Types

(2) Pitch and Row

Engaging Side:

1.27 mm pitch  $\times 2.54$  mm in 2 rows

Board Mount Side: 2.54 mm pitch  $\times 1.905 \text{ mm}$  in zigzag of 4 rows

(3) Cap Header Type

Horizontal/Panel & Board Mount Type

(4) Mounting on Panel & Board Screw Mount (M 2.5 Screws) / Self Mount (Retention Leg)

(5) Applicable Panel

1.6 mm max.

(6) Applicable Board

Thickness:

0.8-1.6 mm Solder-Resistance

Treatment to be applied on soldering face.

(7) Applicable Wire Size

To be specified in Fig. 3.

Wire Size		ted mild copper wire)	Insulatio		
AWG #28	Composition 7/0.127		Outside Diameter	Material	Remarks
AWG #30	7/0.127	0.38	0.5~0.75	PVC or	Discrete
AWG #28	7/0.127	0.38	1.0 MAX	equivalent	Flat Ribbon

Fig. 3

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3.2 Material and Finish: 108-5238-1 (1) Receptacle Contact: Material: Phosphor Bronze  $1.0~\mu m$  min. thick nickel underplate all over 0.2  $\mu m$  or 0.76  $\mu m$ Finish: min. thick gold-plated for contact area only, and 1.0  $\mu$ m min. thick solder-plated for termination area. (2) Post Contact: Material: Phosphor Bronze Finish: 1.0 m min. thick nickel underplate all over 0.2  $\mu m$  or 0.76  $\mu m$ NUMBER min. thick gold-plated for contact area only, and 1.0  $\mu$ m min. thick solder-plated for tyne area only (3) Plug, Cap, Cover Housing and Tyne Plate: Material: Glass-filled Thermoplastic, Polyester UL Flame Retardant Grade: UL 94V-0 Color: Black / Gray (4) Plug Metal Shell: Material: Cold Rolled Steel Sheet Finish: Bright-tin Plating over Copper Underplate SECURITY CLASSIFICATION: (5) Cap Metal Shell: Material: Zinc Die Cast Finish: Nickel-plasted over Copper Underplate (6) Locking Spring: Material: Stainless Steel (7) Shield Case: Material: Molded ABS Resin, and Zinc Die Cast Finish: Nickel-plated over Copper Underplate 3.3 Appearance:

The connectors shall be free from scratches, cracking, deformation, blister, dirt and burrs, that are detrimental to connector functions and merchandising value.

Product Performance :

4.1 Rating:

(1) Rated Voltage:

AC 100 V

(2) Rated Current:

1 A max.

(3) Operating Temperature Range: -55 °C~+85 °C

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AMPLIMITE 050 SERIES II CONNECTOR TYPE B 4.2 Quality Assurance Provisions:

## 4.2.1 Test Environments:

The performance test shall be made on the environmental conditions listed below, unless otherwise specified.

Temperature:

15~35°C

Relative Humidity:

45~75%

Atmospheric Pressure: 650~800 mmHg

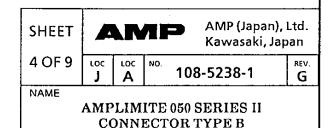
## 4.2.2 Test Samples:

- (1) The product samples to be used at the performance test shall conform to applicable product drawings.
- (2) Wires to be used for termination shall conform to those specified in Para. 3.1 (7) and applicable tools shall be used for termination.
- (3) No test sample shall be reused in the test, unless otherwise specified.
- (4) Shield case is excluded from the testing items.

#### 4.3 Electrical Performance:

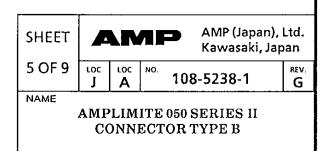
Para.	Test Items	Requirements	Procedures
		Electrical Requirement	nts
4.3.1	Termination Resistance (Low Level)	Initial: $20  m\Omega$ max. After test: $30  m\Omega$ max.	To be measured by using open circuit voltage of 50 mV max. with closed circuit current of 50 mA max. flowing through the test circuit shown in Fig. 6.
4.3.2	Insulation Resistance	1000 ΜΩ	Engage connectors, and measure resistance between adjacent connectors per Condition B (500 V±10 %), Test Method 302 of MIL-STD-202.

Fig. 4 (To be continued)



	Para.	Test Items		Requirem	ents	Procedures
108-5238-1	4.3.3	Dielectric Strength	insul	onormalities si ation break-do over shall take	uch as wn or	Engage connectors, and apply AC 500 V (RMS) between the adjacent contacts for 1 min. per Test Method 301 of MIL-STD-202.
mer NUMBER:	4.3.4	Temperature Rising vs. Current	30°C	max.		After all the contacts serieswired, mate connectors, and measure temperature rising at the points shown in Fig. 6 by thermocouple method. Use test current of 1 A and from the measured value, deduct the room temperature.
Customer Release		4.4.1 Connectpor Insertion / Extraction	# of Pos.	Insertion	Extraction	Attach plug and cap assemblies properly to tensile tester, insert and
	4.4.1	Force	20	2.0 kg max.	0.5 kg min.	extract at the rate of speed of 100
: NOE:			28	3.0 kg max.	0.6 kg min.	mm/min., and read the insertion and extraction forces required.
SECURITY CLASSIFICATION:			36	5.0 kg max.	0.8 kg min.	* The value regarding grounding
¥5			50	6.0 kg max.	1.0 kg min.	indents is to be separately specified.
			68	7.5 kg max.	1.5 kg min.	
			96	10.5 kg max.	2.0 kg min.	
	4.4.2	Durability (Repeated Mate/Unmating)	probl (Low- Resis (Inse	earance) No phem toleratedlevel Terminatance) To meetorion/Extraction	tion 4.3.1.	Repeat insertion and extraction for 500 cycles in the same manner as specified in Para. 4.4.1.

Fig. 4 (To be continued)



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7	Para.	Test Items	Requirements	Procedures
Release 08 5238-	4.4.3	Vibration Sinusoidal High Frequency	No electrical discontinuity greater than 1 microsecond shall take place during the test. (Low-level Termination Resistance) To meet 4.3.1 (Appearance) No physical problem tolerated.	Engage the connectors with all the contacts series-wired, apply test vibration changing to reciprocate 10-500-10 Hz one cycle every 15 min. to the connector fixed on the jig.  Maximum amplitude shall be 1.52 mm both sides, 10 G at the peak, as specified in Test Condition A, Test Method 204 of MIL-STD-202.  Vibration shall be applied to three axial directions 3 hours each, totally 9 hours.
CLASSIFICATION: CLIST	4.4.4	Physical Shock	No electrical discontinuity greater than 1 microsecond shall take place during the test. (Low-level Termination Resistance) To meet 4.3.1. (Appearance) No physical problem tolerated.	Engage the connectors with all the contacts series-wired, and applying test current of 100 mA to the circuit, test in accordance with Test Condition A, Test Method 213 of MIL-STD-202. The vibration shall be: Standard holding time: 6 mesc.  Max. value: 50 g's  Waveform: Semi-sine waveform  Directions and Number of Cycles: 3 Drops each in X, Y and Z (total 18 times)
	4.4.5	Resistance to Soldering Heat		Mount connector on the board, and dip in a molten solder bath so that the underside of the board is held in the bath.  Molten solder  Temperature: 260±5°C  Dipping time: 3 sec.

Fig. 4 (to be continued)

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8-	Para.	Test Items	Requirements		Procedures					
-523	<u> </u>		Environmental Requireme							
108	4.5.1	Humidity-Temperature Cycling Thermal Shock	(Insulation Resistance) 500 M min. (Dielectric Strength) To meet 4.3.3. (Low-level Termination Resistance) To meet 4.3.1. (Low-level Termination	Engage connectors, and test per Test Method 106 D of MIL-STD-202. Test cycle (24 hrs.): 25 °C→65 °C→25 °C→65 °C→25 °C under relative humidity of 80~98%. Repeat this test cycle 10 times.  Engage connectors, and test 5 cycles of end per Condition A (see table below), Test Method 107 D of MIL-STD-202.						
Release	4.5.2		Resistance) To meet 4.3.1. (Appearance) No physical problem tolerated.							
				Step 1	Temp. (°C) -55 +0 -3	Time (min.)				
				2	25 <sup>+10</sup> <sub>-5</sub>	5 Max.				
				3	$85 \begin{array}{c} +3 \\ -0 \end{array}$	30				
1				4	$25 \begin{array}{c} +10 \\ -5 \end{array}$	5 Max.				
	4.5.3		(Low-level Termination Resistance) To meet 4.3.1. (Appearance) No physical problem tolerated.	Engage connectors, and test for 250 hrs. at 85±2 °C (Condition B) per Test Method 108 A of MIL-STD-202.						

Fig. 4 (end)

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## 5. Test Sequence:

All the tests shall be performed in accordance with the test sequence specified below.

T	Y. N				Test C	roup			
Test Item	Item No.	1	2	3	4	5	6	7	8
Appearance	3.3	1	1	1	1	1	1	1	1
Low-level Termination Resistance (Initial)	4.3.1	3	2	2	2	2			
Insuration Resistance (Initial)	4.3.2						2		
Dielectric Strrngth (Initial)	4.3.3						3		
Temperature Rising	4.3.4							2	
Connector Insuretion / Extraction Force	4.4.1	2							
Durability	4.4.2	4							
High Frequency Vibration	4.4.3					3			
Physical Shock	4.4.4	·				4			
Soldering Heat Resistivity	4.4.5								2
Humidity Resistance	4.5.1		3				4		
Thermal Shock	4.5.2			3					
Heat Aging	4.5.3				3				
Low-level Termination Resistance (Final)	4.3.1	6	4	4	4	5			
Insulation Resistance (Final)	4.3.2						5		
Dielectric Strength (Final)	4.3.3						6		
Connector Insertion / Extraction Force (End)	4.4.1	5							
Appearance (End)	3.3		5	5	5	6	7	3	3
No. of Test Samples		5	3	3	3	3	3	1	1

(Note) 1. To be tested in groups in sequence indicated by encircled figure.

Fig. 5

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